



Bill of Materials

TI DESIGNS

#	Quantity	Label	Value	Footprint
1	1	Vout		
2	1	R1	1k	R_AX300_W100
3	1	R2	1k	R_AX300_W100
4	1	R3	1k	R_AX300_W100
5	1	R4	1k	R_AX300_W100
6	1	C1	1u	C_AX200_W120
7	1	C2	1u	C_AX200_W120
8	1	Vcc	3.3	
9	1	R5	866	R_AX300_W100
10	1	CMP-		
11	1	CMP+		
12	1	Comparator		DIP8
13	1	Vcm		JP100
14	1	VIN-		
15	1	Vin		JP100
16	1	VIN+		

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